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**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>q</sub> (Max.) (nC)

Configuration

# **Power MOSFET**

S

N-Channel MOSFET

0.55

400

36

9.9

16

Single

 $V_{GS} = 10 V$ 

## FEATURES

Low gate charge Q<sub>g</sub> results in simple drive requirement



- Improved gate, avalanche, and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Effective C<sub>oss</sub> specified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptable power supply
- High speed power switching

### **TYPICAL SMPS TOPOLOGIES**

- · Single transistor flyback Xfmr. reset
- Single transistor forward Xfmr. reset (both for US line input only)

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	IRF740APbF	
Lead (Pb)-free and halogen-free	IRF740APbF-BE3	

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	400	N	
Gate-source voltage		V <sub>GS</sub>	± 30	V	
Continuous durin surrent	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	10	
Continuous drain current		T <sub>C</sub> = 100 °C		6.3	А
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	40		
Linear derating factor			1.0	W/°C	
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	630	mJ	
Repetitive avalanche current <sup>a</sup>		I <sub>AR</sub>	10	A	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	12.5	mJ
Maximum power dissipation	T <sub>C</sub> = 25 °C		PD	125	W
Peak diode recovery dV/dt <sup>c</sup>		dV/dt	5.9	V/ns	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering recommendations (peak temperature) <sup>d</sup>	For	10 s		300 <sup>d</sup>	C
Mounting torque	6-32 or M3 screw			10	lbf ∙ in
				1.1	N · m

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 12.6 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 10$  A (see fig. 12)

c.  $I_{SD} \le 10$  A,  $dV/dt \le 330$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C

d. 1.6 mm from case

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PARAMETER	SYMBOL	TYP.	MAX		UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	62 - 1.0				
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-			°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	1.0					
SPECIFICATIONS ( $T_J = 25 \ ^{\circ}C$ ,	unless otherw	/ise noted)						
PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNI	
Static				-	-	-		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 250 μA	400	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.48	-	V/°(	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	′ <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V	
Gate-source leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>S</sub> = ± 30 V	-	-	± 100	nA	
Zava acta valtaga dusia sument	I	$V_{DS} = 4$	00 V, V <sub>GS</sub> = 0 V	-	-	25	μA	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 320 V, V	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250		
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 6.0 A <sup>b</sup>	-	-	0.55	Ω	
Forward transconductance	g <sub>fs</sub>	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 6.0 \text{ A}^{b}$		4.9	-	-	S	
Dynamic					•	•	<u> </u>	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	1030	-	-	
Output capacitance	C <sub>oss</sub>	V	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		170	-		
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.0			7.7	-		
	0	$V_{GS} = 0 V, V_{DS}$	<sub>S</sub> = 1.0 V, f = 1.0 MHz	-	1490	-	- pF	
Output capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 320 V, f = 1.0 MHz		-	52	-		
Effective output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$ , $V_{DS} = 0 V$ to 320 V		-	61	-		
Total gate charge	Qg			-	-	36	nC	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 10 A, V <sub>DS</sub> = 320 V, see fig. 6 and 13 <sup>b</sup>	-	-	9.9		
Gate-drain charge	Q <sub>gd</sub>			-	-	16		
Turn-on delay time	t <sub>d(on)</sub>			-	10	-		
Rise time	tr		00 V Ia – 10 A	-	35	-	1	
Turn-off delay time	t <sub>d(off)</sub>	$V_{DD}$ = 200 V, I <sub>D</sub> = 10 A, R <sub>g</sub> = 10 Ω, R <sub>D</sub> = 19.5 Ω, see fig. 10 <sup>b</sup>		-	24	-	- ns	
Fall time	t <sub>f</sub>			-	22	-		
Drain-Source Body Diode Characteris	tics	-						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	- A	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	40		
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I	$T_J = 25 \ ^{\circ}C, \ I_S = 10 \ A, \ V_{GS} = 0 \ V^b$		-	2.0	V	
Body diode reverse recovery time	t <sub>rr</sub>	T 25 °C	10 A, dl/dt = 100 A/µs <sup>b</sup>	-	240	360	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	ij – 25 0, if =	$10 A, u/u = 100 A/\mu S^{2}$	-	1.9	2.9	μΟ	
Forward turn-on time	t <sub>on</sub>	Intrinsic turn	-on time is negligible (tu	rn-on is do	minated b	by L <sub>S</sub> and	L <sub>D</sub> )	

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq 300~\mu s;~duty~cycle \leq 2~\%$ 

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

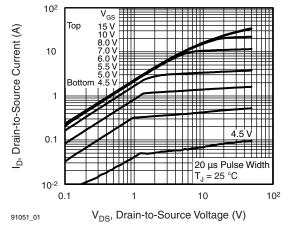


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

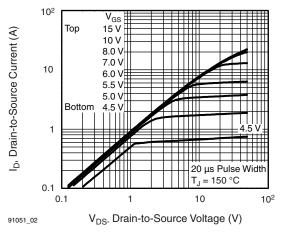


Fig. 1 - Typical Output Characteristics,  $T_C = 150$  °C

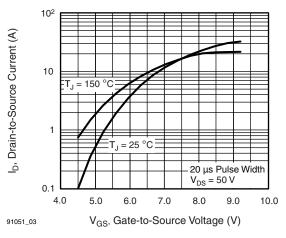


Fig. 2 - Typical Transfer Characteristics

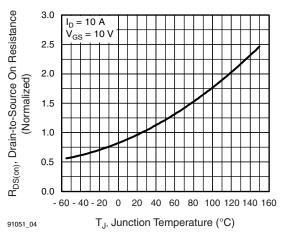


Fig. 3 - Normalized On-Resistance vs. Temperature

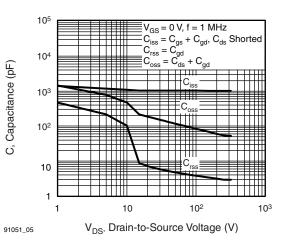


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

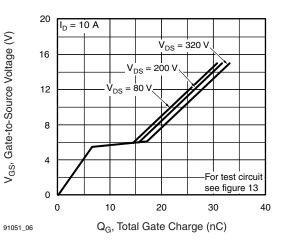


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

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**3** nical questions contact: hym@visha Document Number: 91051

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**IRF740A** 

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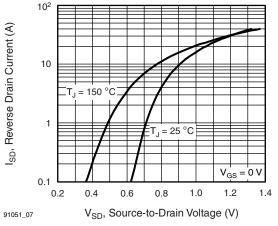


Fig. 6 - Typical Source-Drain Diode Forward Voltage

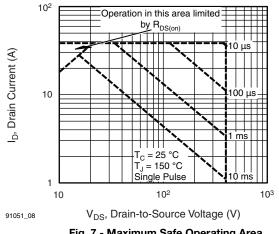


Fig. 7 - Maximum Safe Operating Area

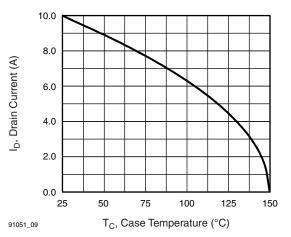


Fig. 8 - Maximum Drain Current vs. Case Temperature

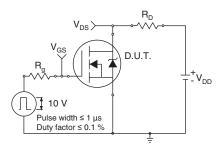


Fig. 9 - Switching Time Test Circuit

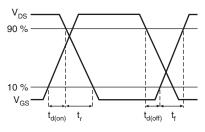
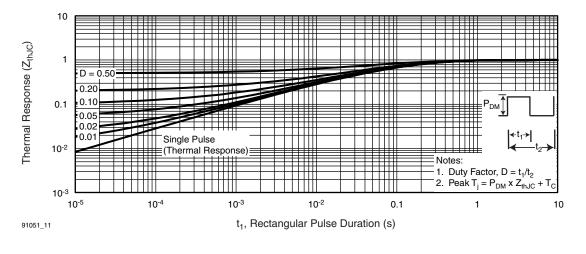


Fig. 10 - Switching Time Waveforms



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### Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

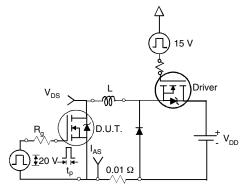


Fig. 12 - Unclamped Inductive Test Circuit

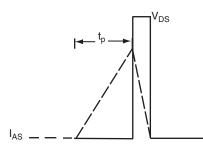


Fig. 13 - Unclamped Inductive Waveforms

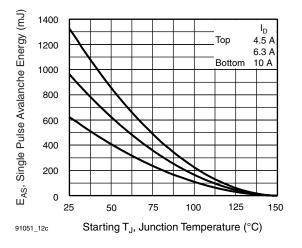


Fig. 14 - Maximum Avalanche Energy vs. Drain Current

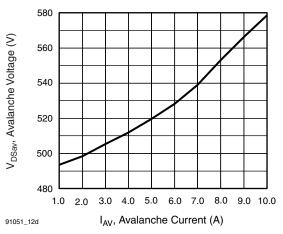


Fig. 15 - Typical Drain-to-Source Voltage vs. Avalanche Current

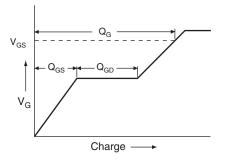


Fig. 16 - Basic Gate Charge Waveform

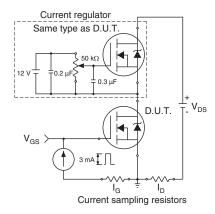


Fig. 17 - Gate Charge Test Circuit

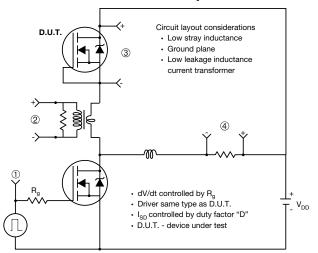
5

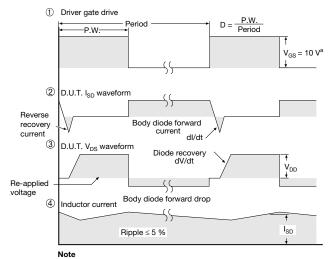






#### Peak Diode Recovery dV/dt Test Circuit





a.  $V_{GS} = 5$  V for logic level devices

Fig. 18 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

### Note

• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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